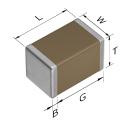
C2012X6S0G226M125AC

RoHS Reach Halogen Free Pb Free

交货型号	C2012X6S0G226MT****	
用途	一般等级	
特点	General 一般(~75V)	
系列	C2012 [EIA 0805]	
状态	↑ 停止生产计划 推荐代替型号 : C2012X6S0J226M125AB (不保证其兼容性。)	



	尺寸
长度 (L)	$2.00 \text{mm} \pm 0.20 \text{mm}$
宽度 (W)	1.25mm ±0.20mm
厚度(T)	1.25mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)
推存产益作向(FA)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
3年行产型:710/PJ (LD)	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
1年付2年11月1日(10)	0.90mm to 1.20mm(Reflow Soldering)

电	气特性
电容	22 μF ±20%
额定电压	4VDC
温度特性	X6S (±22%)
耗散因数(Max.)	15%
绝缘电阻 (Min.)	4ΜΩ

	其他	
焊接方法	流体	
尸按 刀莅	回流	
AEC-Q200	NO	
包装形式	塑封编带 (180mm卷筒)	
包装个数	2000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.



RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

[!] Images are for reference only and show exemplary products.

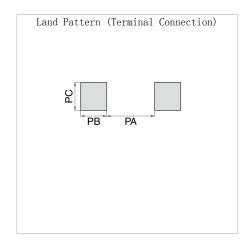
[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free



Associated Images



[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.